









# **CEU01N7**

#### 700V **Δ** 16Ω **Δ** 0.8A **Δ** Si MOSFET

SILICON Si MOSFET ▲ SMD type

N-channel enhancement mode

UL94V-0 rated flame retardant epoxy

TO252 (DPAK) package ▲ MSL 3

Super high dense cell density for extremely low R<sub>DS(ON)</sub>

With ESD diode between Gate and Source

#### **MAXIMUM RATINGS**

Parameter ( $T_c$ = 25°C, unless otherwise noted)		Characteristics
Drain-Source Voltage	V <sub>DS</sub>	700V
Gate-Source Voltage	V <sub>GS</sub>	±30V
Continuous Drain Current at T <sub>C</sub> = 25°C	I <sub>D</sub>	0.8A
Pulsed Drain Current Note 1	I <sub>DM</sub>	3A
Maximum Power Dissipation at T <sub>C</sub> = 25°C	P <sub>D</sub>	31W
Power Dissipation Derating above 25°C	ΔP <sub>D</sub>	0.25W/°C
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55°C to +175°C

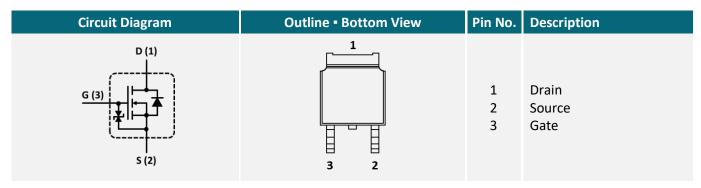
## THERMAL CHARACTERISTICS

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Case	R <sub>TH_JC</sub>	4°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>TH_JA</sub>	50°C/W

## **APPLICATIONS**

Base Station Power	Battery Chargers	LED Lighting	Power Adapters	SMPS
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#### **PIN DESCRIPTION**





## **ELECTRICAL CHARACTERISTICS** ▲ T<sub>C</sub> = 25°C, unless otherwise noted

Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	$BV_{DSS}$	700			V
Zero Gate Voltage Drain Current	$V_{DS} = 700V, V_{GS} = 0V$	I <sub>DSS</sub>			1	μΑ
Gate Body Leakage Current, Forward	$V_{GS} = 30V, V_{DS} = 0V$	$I_{GSSF}$			100	nA
Gate Body Leakage Current, Reverse	$V_{GS} = -30V, V_{DS} = 0V$	I <sub>GSSR</sub>			-100	nA
On Characteristics						
Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_{D} = 250 \mu A$	$V_{GS(th)}$	2		4	V
Static Drain-Source On-Resistance	$V_{GS} = 10V$ , $I_D = 0.5A$	R <sub>DS(ON)</sub>		16	18	Ω
Dynamic Characteristics Note 4						
Input Capacitance	$V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 1MHz$	C <sub>ISS</sub>		135		pF
Output Capacitance	$V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 1MHz$	Coss		45		pF
Reverse Transfer Capacitance	$V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 1MHz$	$C_{RSS}$		20		pF
Switching Characteristics Note 4						
Turn-On Delay Time	$V_{DD} = 300V$ , $V_{GS} = 10V$ , $I_{D} = 0.4A$ , $R_{G(ext)} = 4.7\Omega$	$t_{D(ON)}$		19	38	ns
Turn-On Rise Time	$V_{DD}$ = 300V, $V_{GS}$ = 10V, $I_{D}$ = 0.4A, $R_{G(ext)}$ = 4.7 $\Omega$	$t_R$		13	26	ns
Turn-Off Delay Time	$V_{DD} = 300V$ , $V_{GS} = 10V$ , $I_{D} = 0.4A$ , $R_{G(ext)} = 4.7\Omega$	t <sub>D(OFF)</sub>		24	8	ns
Turn-Off Fall Time	$V_{DD} = 300V$ , $V_{GS} = 10V$ , $I_{D} = 0.4A$ , $R_{G(ext)} = 4.7\Omega$	t <sub>F</sub>		35	70	ns
Total Gate Charge	$V_{DD} = 480V$ , $V_{GS} = 10V$ , $I_D = 0.4A$	$Q_{G}$		6	7.8	nC
Gate Source Charge	$V_{DD} = 480V$ , $V_{GS} = 10V$ , $I_D = 0.4A$	$Q_{GS}$		1		nC
Gate Drain Charge	$V_{DD} = 480V$ , $V_{GS} = 10V$ , $I_D = 0.4A$	$Q_{GD}$		4.4		nC
Drain-Source Diode Characteristics a	nd Maximum Ratings					_
Drain-Source Diode Forward Current		Is			0.8	Α
Drain-Source Diode Forward Voltage Note 2	$V_{GS} = 0V$ , $I_S = 0.8A$	$V_{SD}$			1.5	V

#### **Notes**

- 1: Drain current limited by maximum junction temperature.
- 2: Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3: Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4: Guaranteed by design, not subject to production testing.



#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE



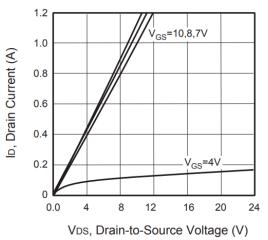


Fig. 2 • Transfer Characteristics

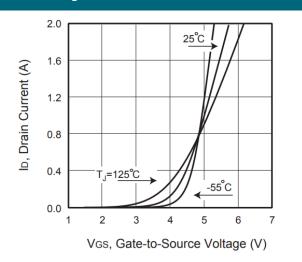


Fig. 3 • Capacitance

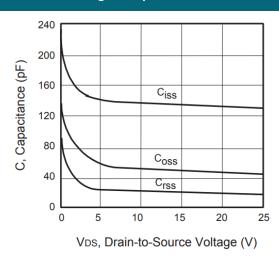


Fig. 4 • On-Resistance Variation with Temperature

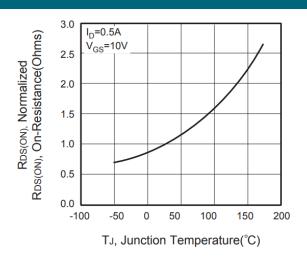


Fig. 5 • Gate Threshold Variation with Temperature

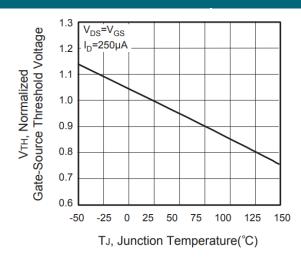
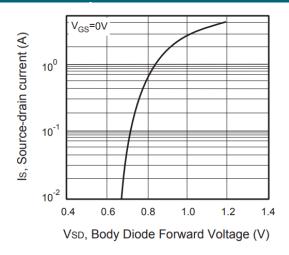


Fig. 6 • Body Diode Forward Voltage Variation with Source Current



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#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

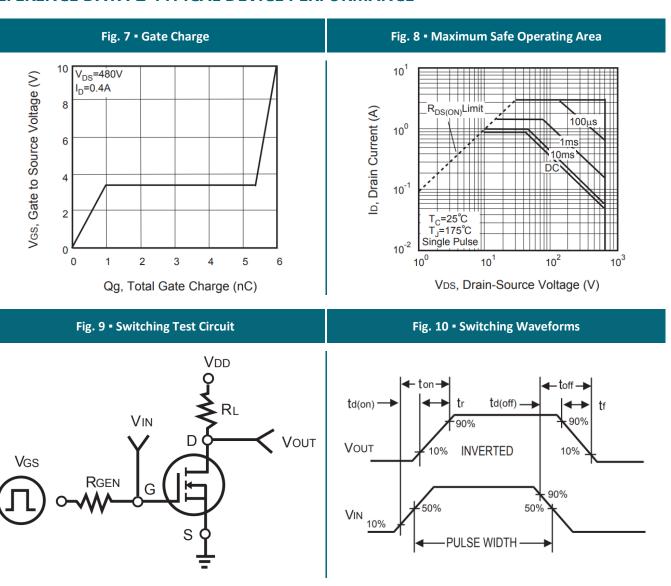
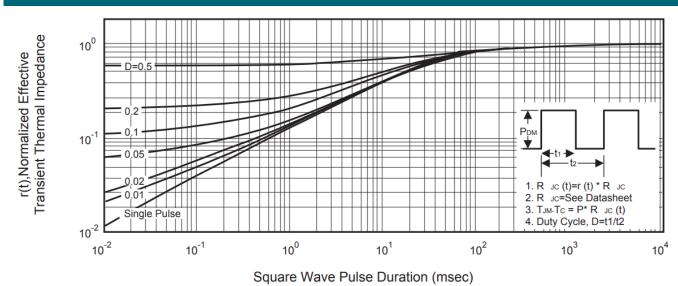


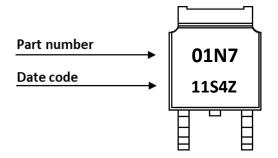
Fig. 11 - Normalized Thermal Transient Impedance Curve



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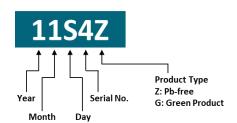


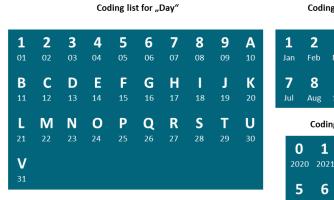
#### **PART MARKING**



## **DATE CODE**

Example: 11S4Z

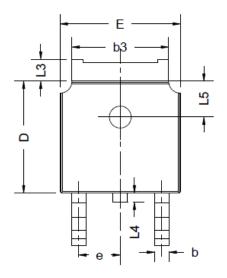


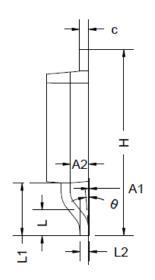


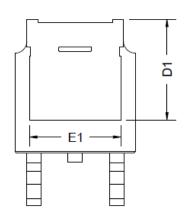


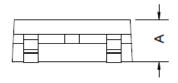


## **PACKAGE OUTLINE**









Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)	
Α	2.20	2.30	2.38	
A1	0.00	-	0.20	
A2	A2 0.90 1.07		1.17	
b	0.68	0.78	0.90	
b3	5.23	5.33	5.46	
С	0.43	0.53	0.61	
D	5.98	6.10	6.22	
D1		5.30 REF		
Е	6.40	6.60	6.73	
E1	4.63	-	-	

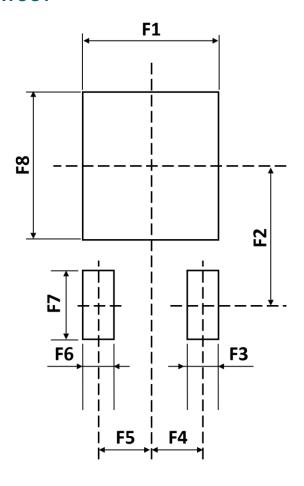
Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)				
е		2.286 BSC					
Н	9.40	10.10	10.50				
L	1.38	1.50	1.75				
L1	2.90 REF						
L2		0.51 BSC					
L3	0.88	-	1.28				
L4	0.50		1.00				
L5	1.65	1.80	1.95				
θ	0°	-	8°				

## **ORDERING INFORMATION**

Part Number	Package	Packing	Reel Qty.	Inner Box Qty.	Outer Box Qty.
CEU01N7	TO252 (DPAK)	Reel	2,500pcs	5,000pcs	40,000pcs



## **RECOMMENDED PAD LAYOUT**



Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)	
F1	-	6.00	-	
F2	-	6.25	-	
F3	-	1.40	-	
F4	-	2.29	-	

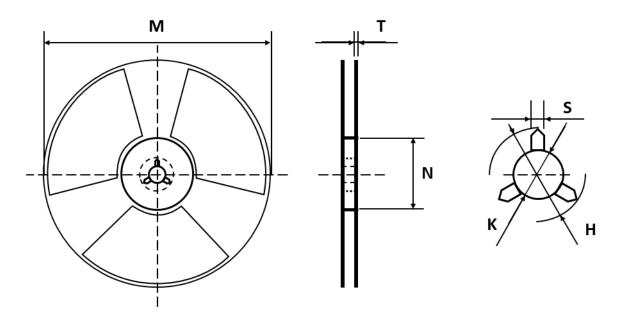
Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
F5	-	2.29	-
F6	-	1.40	-
F7	-	3.00	-
F8	-	6.50	-

#### Notes:

- 1. The suggested land pattern dimensions have been provided for reference only.
- 2. For further information, please reference document IPC-7351A.

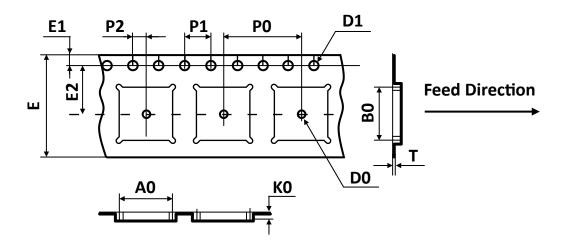


## **REEL DIMENSIONS** ▲ All dimensions in mm



Tape Size	Reel Size	M	N	T	Н	K	S
	Ø330	Ø330.00	Ø100.00	2.10	22.00	13.00	2.00
16mm		±2.00	+0 50	±0.20	±0.50	+0.50	+0.50
		12.00	±0.50	±0.20	±0.50	-0.20	-0.20

# **TAPE DIMENSIONS** ▲ All dimensions in mm

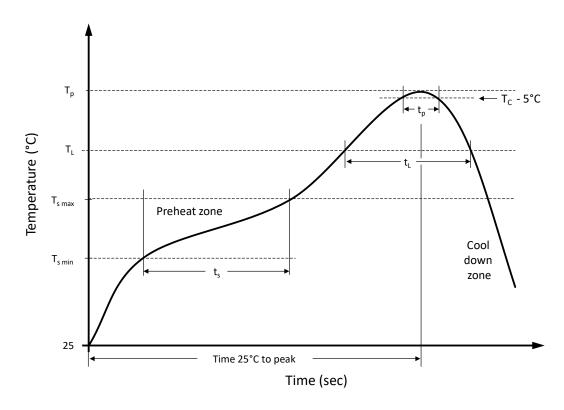


Package	A0	В0	КО	D0	D1	E	E1	E2	P0	P1	P2	Т
TO252	6.90	10.50	2.70	1.50	1.50	16.00	1.75	7.50	8.00	4.00	2.00	0.30
(DPAK)	±0.10	±0.10	±0.10	MIN	±0.10	+0.30	±0.10	±0.10	±0.10	±0.10	±0.10	±0.05

Note: All dimensions meet EIA-481-D requirements.



## RECOMMENDED REFLOW SOLDERING PROFILE



## **Recommended reflow soldering conditions** ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	$T_{s min}$	100 °C	150 °C
Preheat temperature max.	T <sub>s max</sub>	150 °C	200 °C
Preheat time t <sub>s</sub> from T <sub>s min</sub> to T <sub>s max</sub>	ts	120 seconds	120 seconds
Ramp-up rate (T₁ to Tp)		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	$T_L$	183 °C	217 °C
Time t <sub>L</sub> maintained above T <sub>L</sub>	t <sub>L</sub>	150 seconds max.	150 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	t <sub>p</sub>	20 seconds max.	30 seconds max.
Ramp-down rate (T <sub>L</sub> to T <sub>p</sub> )		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes



#### **REVISION TABLE**

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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